

Edition 1.0 2009-05

INTERNATIONAL STANDARD

Materials for printed boards and other interconnecting structures – Part 4-16: Sectional specification set for prepreg materials, unclad (for the manufacture of multilayer boards) – Multifunctional non-halogenated epoxide woven E-glass prepreg of defined flammability (vertical burning test) for lead-free assembly

IEC 61249-4-16:2009

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRICE CODE

N

ICS 31.180

ISBN 978-2-88910-468-0

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

MATERIALS FOR PRINTED BOARDS AND OTHER INTERCONNECTING STRUCTURES –

Part 4-16: Sectional specification set for prepreg materials, unclad (for the manufacture of multilayer boards) – Multifunctional non-halogenated epoxide woven E-glass prepreg of defined flammability (vertical burning test) for lead-free assembly

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International Standard IEC 61249-4-16 has been prepared by IEC technical committee 91: Electronics assembly technology.

The text of this standard is based on the following documents:

FDIS	Report on voting
91/852/FDIS	91/864/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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